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ATLAS Pixel collaboration

Test beam results on ATLAS Pixel sensors

Pixel2002

Carmel, 10/09/2002

Overview

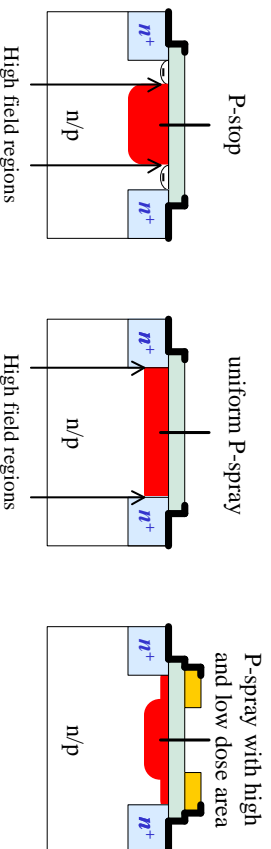
Pixel detectors with the ATLAS production design (oxygenated silicon sensors + DSM rad-hard electronics) have been irradiated to 1.1×10^{15} neq cm^{-2} and 600 kGray.

They have been tested at CERN with a 180 GeV pion beam.

The following measurements have been performed:

- Depletion depth
- Charge collection
- Detection efficiency
- Spatial resolution

ATLAS Pixel sensors



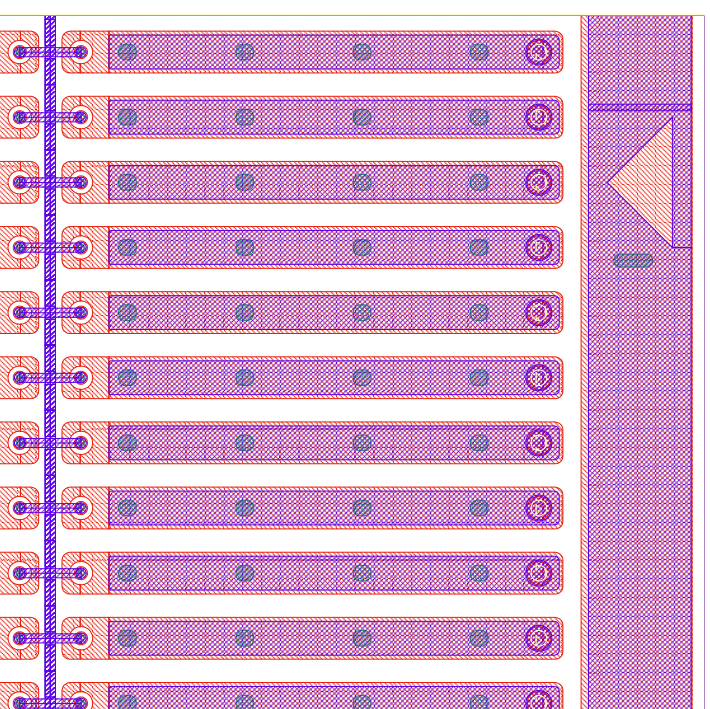
Oxygenated silicon

$50 \times 400 \mu\text{m}^2$ pixels

$250 \mu\text{m}$ thickness

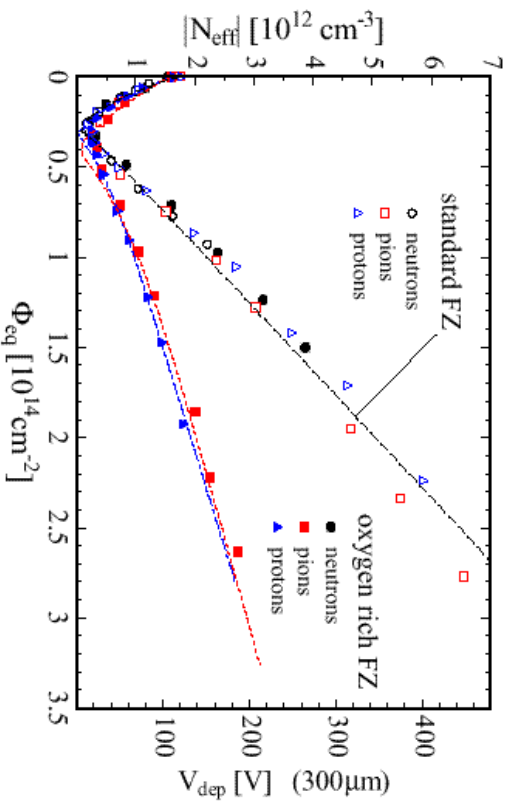
$8 \times 8 \text{ mm}^2$ (single chip) or

$16 \times 64 \text{ mm}^2$ (module) size

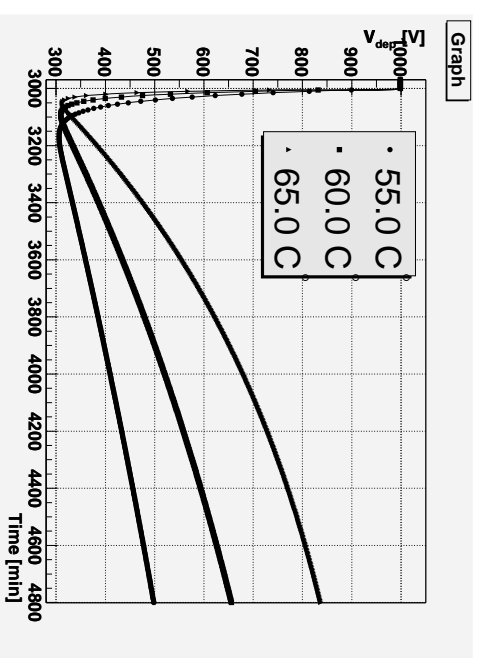


Irradiation

Several single chip assemblies with oxygenated silicon have been irradiated to 1.1×10^{15} neq cm^{-2} and 600 kGray.



ROSE collaboration
NIM A466, 308

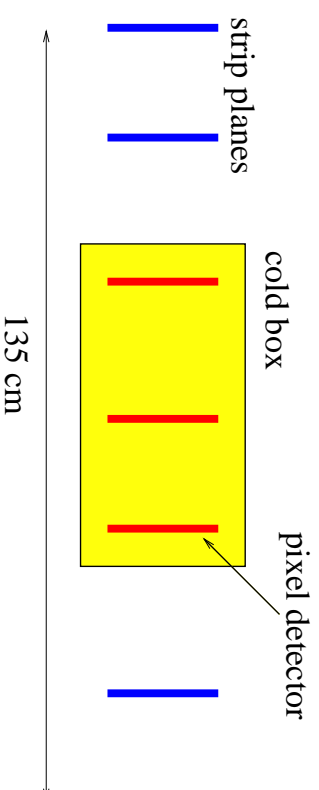


O. Krasel

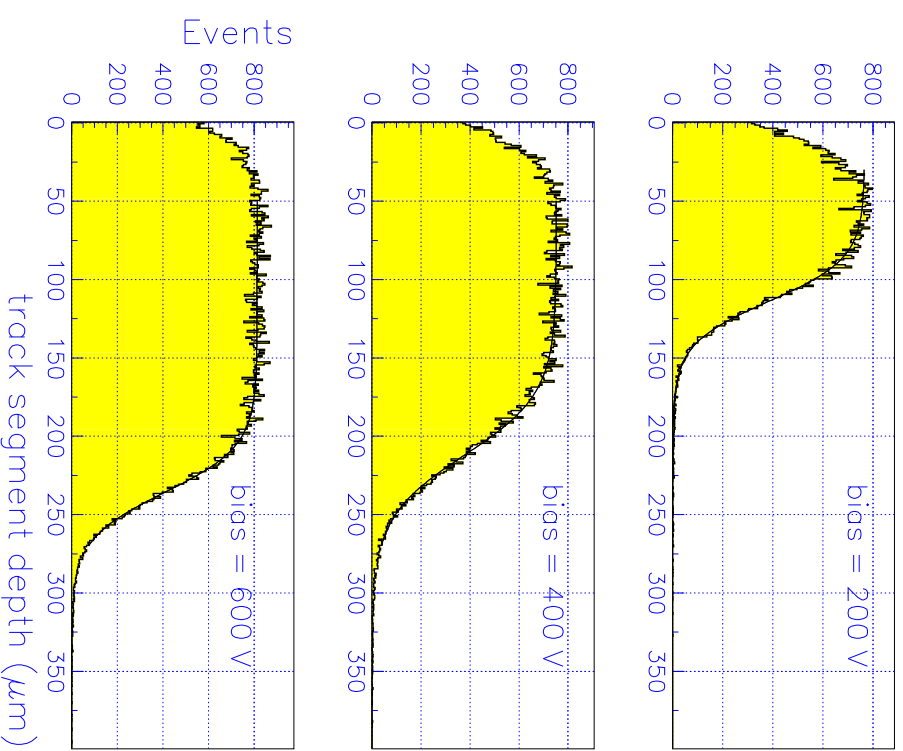
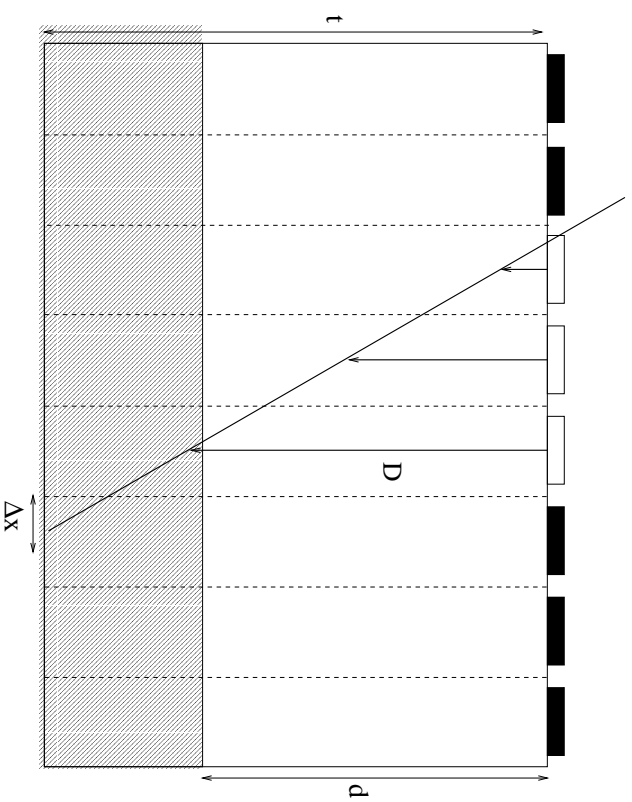
Testbeam setup

4 planes of double-sided microstrip planes track the particles with a resolution of $\sim 6 \mu\text{m}$ at the pixel detector planes.

Pixel detectors are inside a cold box.



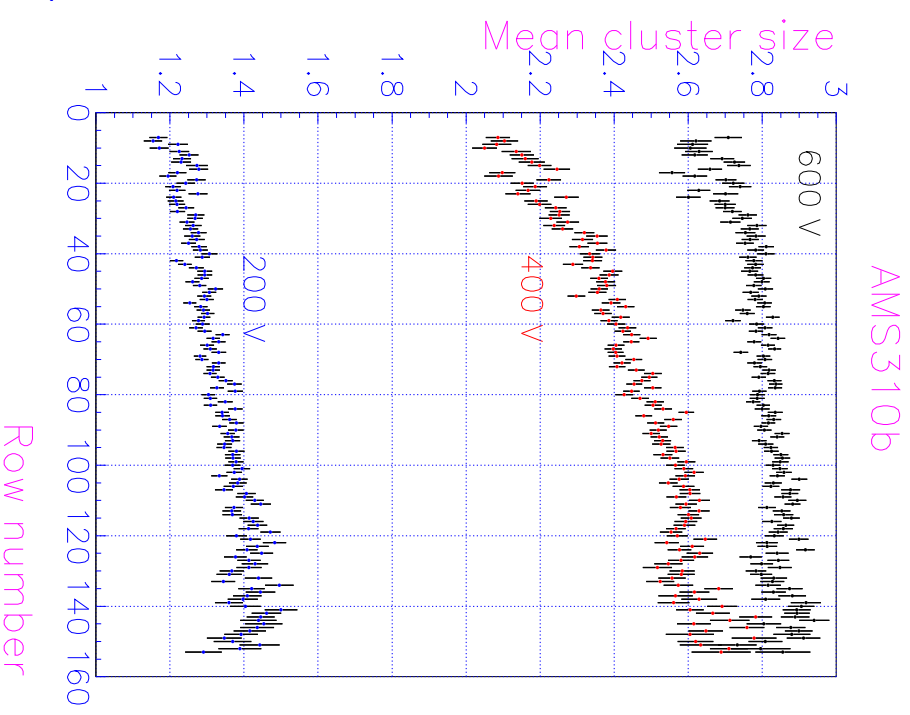
Measurement of depletion depth



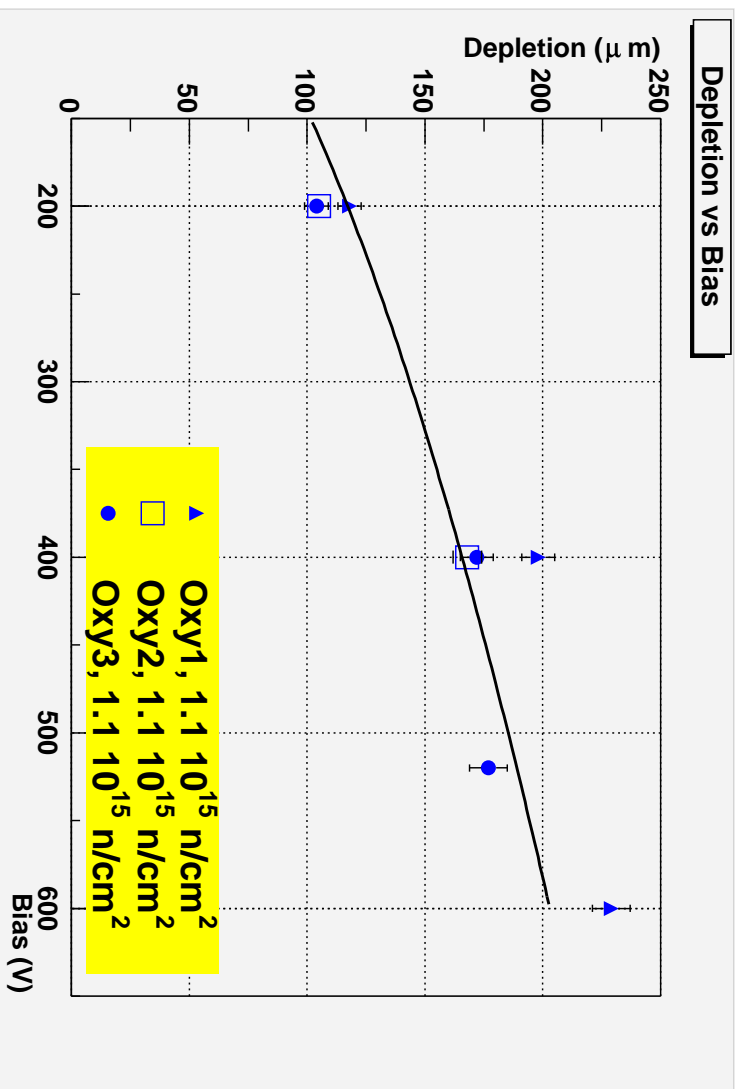
Not uniform irradiation

rows	depletion
7-49	$175 \pm 4 \pm 6$
50-79	$189 \pm 4 \pm 6$
80-109	$206 \pm 3 \pm 7$
110-151	$220 \pm 6 \pm 7$

Leakage current decreases with row number. The same behaviour is observed for all the irradiated detectors.

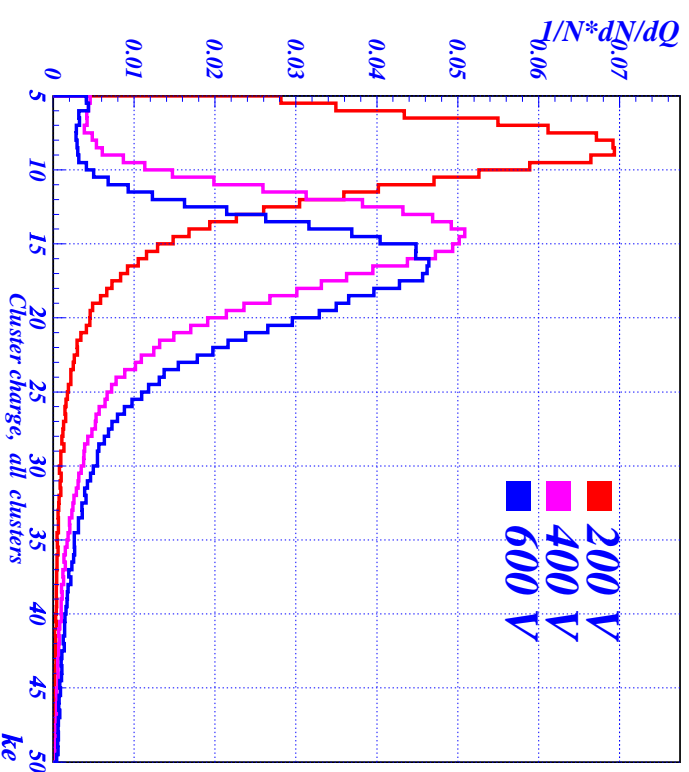


Summary of depletion measurements



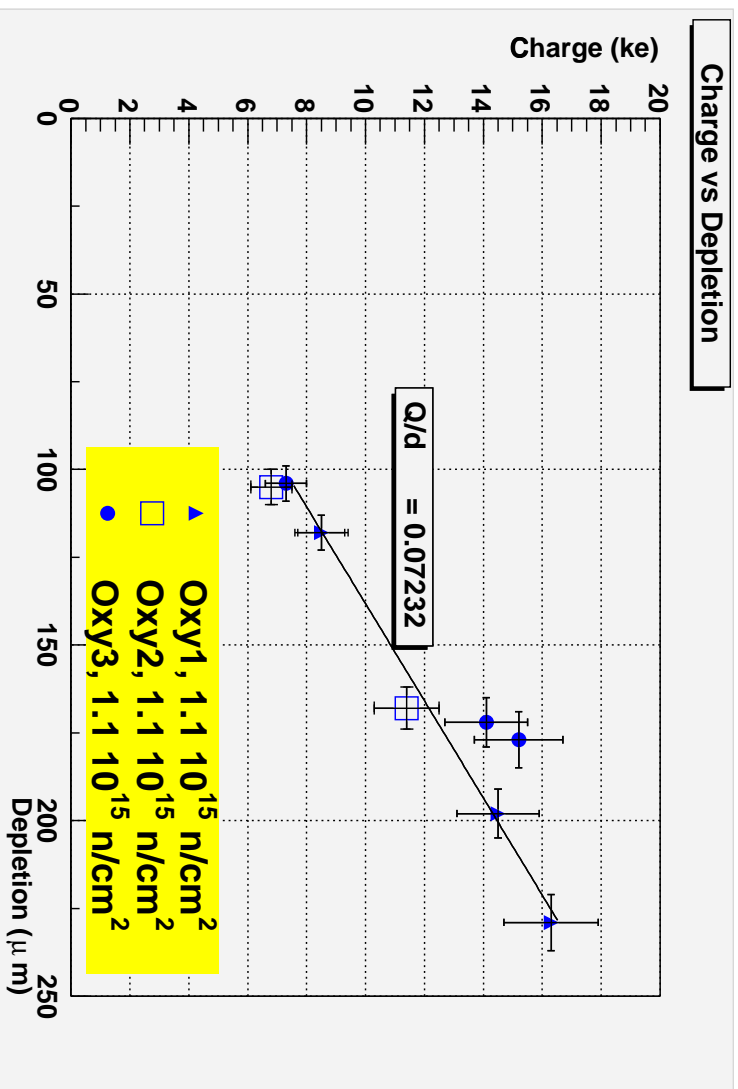
Pulse height

The charge is measured using the time over threshold of the signal.
The accuracy of the calibrations is about 10%

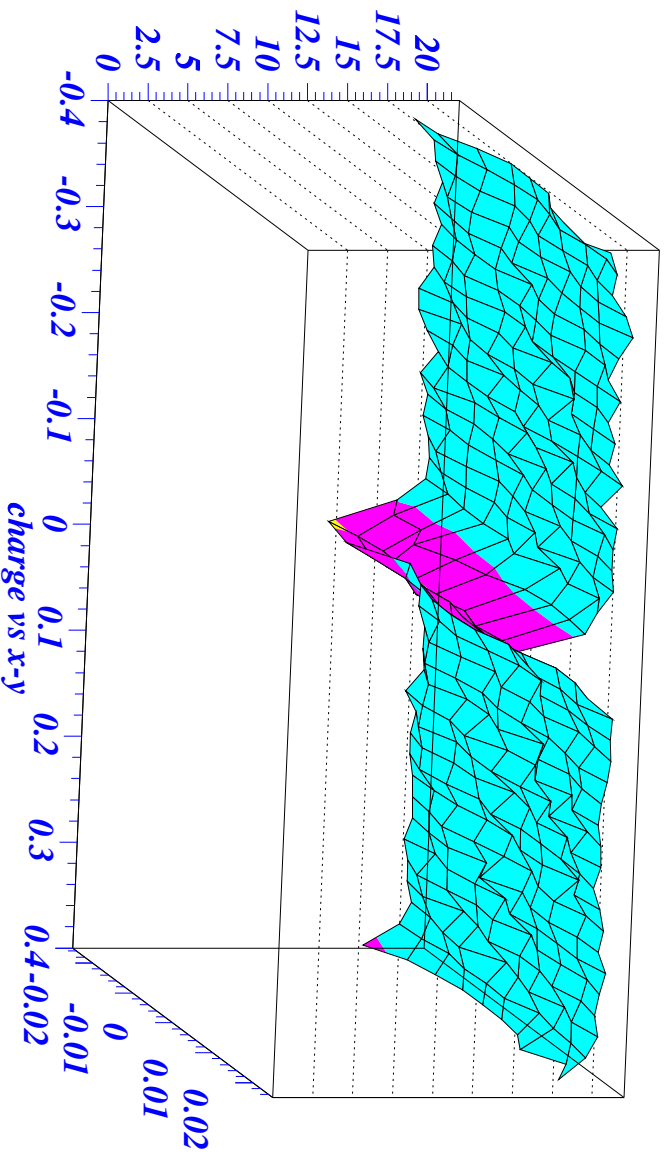


Pulse height vs depletion

The most probable pulse height measured at 0 degree incidence angle scales as the depletion



Charge collection uniformity



Charge collection as a function of track position inside a pair of pixel cells

Efficiency

Efficiency as a function of the difference between the arrival time of the particle (from a scintillator) and the clock edge

$$\epsilon = 98.2 \%$$

$$\tau = 1.75 \text{ ns}$$

$$\sigma = 4.34 \text{ ns}$$

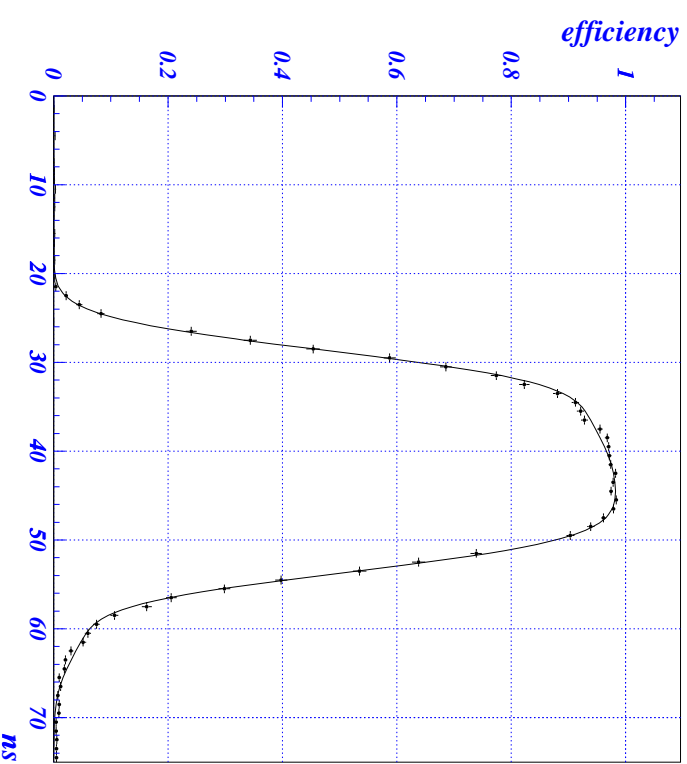
Fitting function:

$$0 \quad [0, t_0]$$

$$\epsilon - e^{-(t-t_0)/\tau} \quad [t_0, t_0 + 25]$$

$$e^{-(t-t_0-25)/\tau} - e^{-(t-t_0)/\tau} \quad [t_0 + 25, 75]$$

+ gaussian smearing

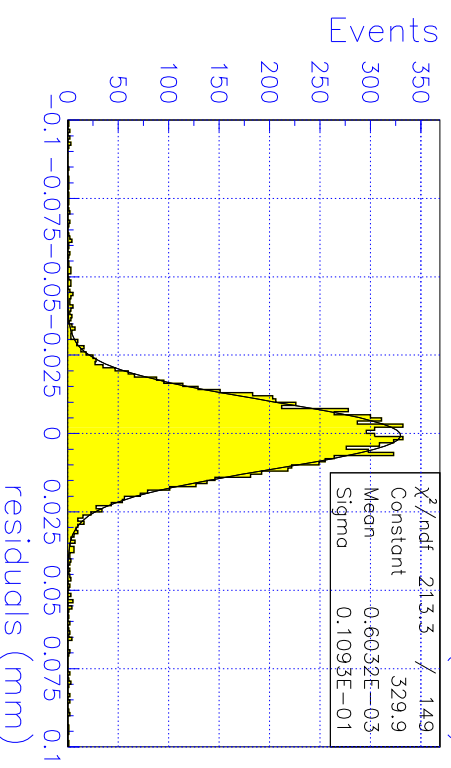
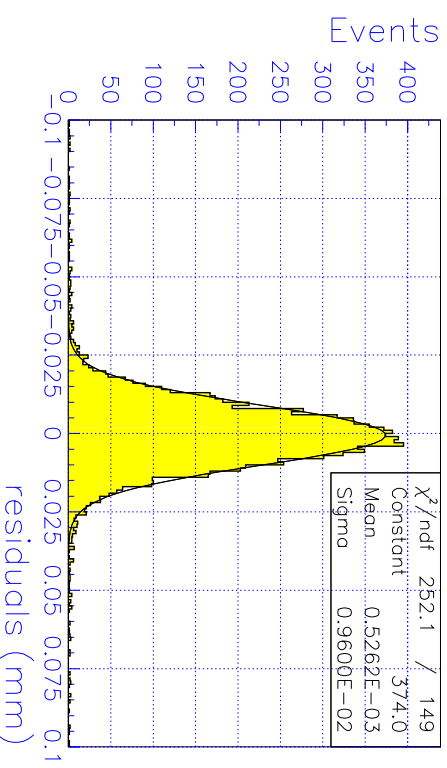


Spatial residuals

Irradiated detector at 10 degrees incidence angle

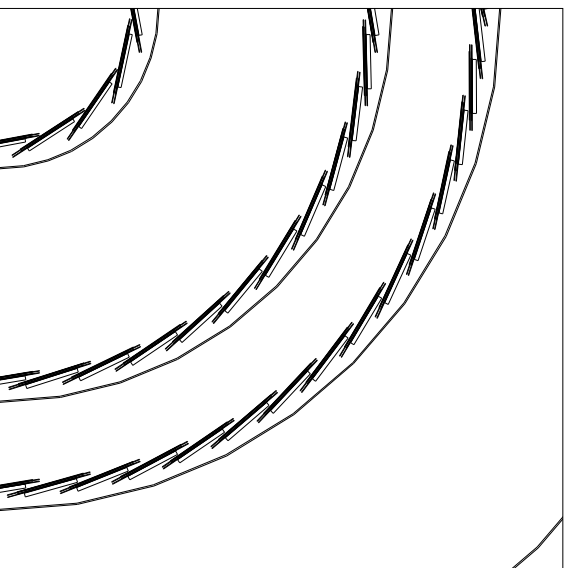
AM5310b 600 V, 10 degrees

Residuals with charge interpolation
for clusters with more than one pixel
 $\sigma = 9.6 \mu\text{m}$



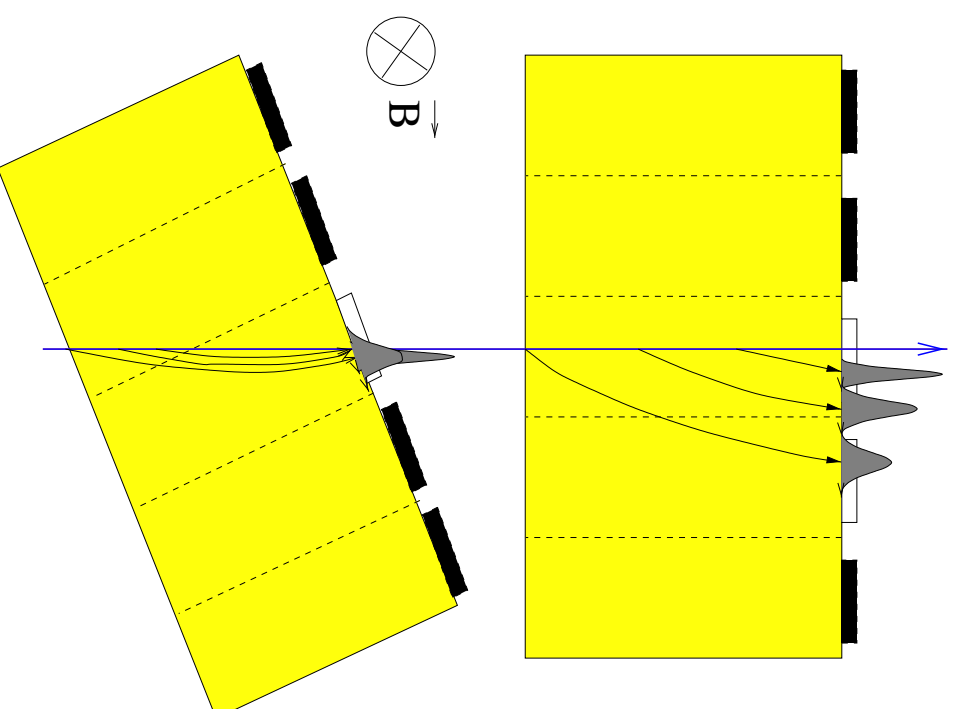
Digital residuals
 $\sigma = 10.9 \mu\text{m}$

Effective incidence angle in ATLAS



tilt angle = 20 degrees

Lorentz angle = 5 degrees
at 600 V, full depletion



Conclusions

ATLAS Pixel detectors with oxygenated silicon sensors have been irradiated to the design fluence and operated at the test beam.

The depletion depth and charge collected were consistent with expectations and allowed to obtain the efficiency and spatial resolution required in ATLAS.

The depletion depth at 600 V is $229 \pm 8 \mu\text{m}$

The detection efficiency is 98.2 %

The spatial resolution at 10 degrees is $9.6 \mu\text{m}$